

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = 25°C
	21mΩ @ V _{GS} = 10V		9.4A
Q1	30V	$32m\Omega @ V_{GS} = 4.5V$	7.3A
00	00) (39mΩ @ V _{GS} = -10V	-6.8A
Q2	-30V	$53 \mathrm{m}\Omega @ \mathrm{V}_{\mathrm{GS}} = -4.5 \mathrm{V}$	-5.8A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor control
- Power Management Functions
- DC-DC Converters
- Backlighting



Top View

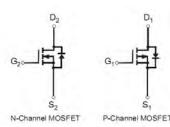
Bottom View

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

- Case: TO252-4L
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.027 grams (approximate)



Ordering Information (Note 3)

Part Number	Case	Packaging
DMC3021LK4-13	TO252-4L	2500/Tape & Reel

TO252-4L

Notes: 1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



) | | = Manufacturer's Marking C3021L = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01 - 53)



Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 4)	PD	2.75	W
Thermal Resistance, Junction to Ambient (Note 4)	R _{θJA}	46.3	°C/W
Total Power Dissipation (Note 5)	PD	1.52	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	81.3	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Maximum Ratings N-CHANNEL - Q1 @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units V	
Drain-Source Voltage		V _{DSS}	30		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 4) V_{GS} = 10V	Steady State	T _A = 25°C T _A = 70°C	ID	9.4 7.5	А
Continuous Drain Current (Note 5) V_{GS} = 10V	Steady State	T _A = 25°C T _A = 70°C	ID	6.7 5.4	А
Continuous Drain Current (Note 4) V_{GS} = 4.5V	Steady State	T _A = 25°C T _A = 70°C	ID	7.3 5.8	А
Pulsed Drain Current (Note 6)			I _{DM}	40	А

Maximum Ratings P-CHANNEL – Q2@T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			V _{DSS}	-30	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 4) V_{GS} = -10V	Steady State	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	ID	-6.8 -5.3	А
Continuous Drain Current (Note 5) V_{GS} = -10V	Steady State	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	ID	-5.1 -4.1	А
Continuous Drain Current (Note 4) $V_{GS} = -4.5V$	Steady State	$T_A = 25^{\circ}C$ $T_A = 70^{\circ}C$	ID	-5.8 -4.6	A
Pulsed Drain Current (Note 6)			IDM	-40	A

Notes: 4. Device mounted on FR-4 substrate PC board, 2oz copper, on 1inch square copper plate.

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout
Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.



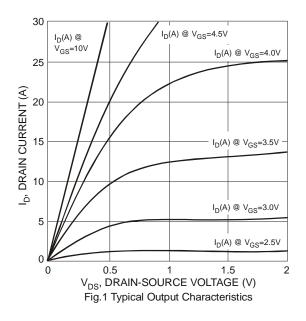
Electrical Characteristics N-CHANNEL – Q1@T_A = 25°C unless otherwise specified

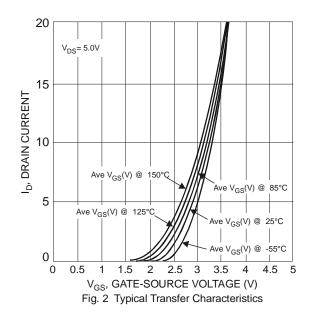
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current $@T_c = 1$	25°C I _{DSS}	-	-	1.0	μA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)					-	
Gate Threshold Voltage	V _{GS(th)}	1	1.5	2.1	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance	Proven	-	14	21	mΩ	$V_{GS} = 10V, I_D = 7A$
	R _{DS (ON)}	-	18	32	111 2 2	$V_{GS} = 4.5V, I_D = 5.6A$
Forward Transfer Admittance	Y _{fs}	-	8.5	-	S	$V_{DS} = 5V, I_D = 7A$
Diode Forward Voltage (Note 6)	V _{SD}	-	0.7	1.0	V	$V_{GS} = 0V, I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	-	751	-	pF	
Output Capacitance	Coss	-	121	-	pF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	110	-	pF	
Gate Resistance	Rg	-	1.5	-	Ω	$V_{DS} = 10V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (4.5V)	Qg	-	9	-	nC	
Total Gate Charge (10V)	Qg	-	17.4	-	nC	$V_{GS} = 10V, V_{DS} = 15V,$
Gate-Source Charge	Q _{gs}	-	2.2	-	nC	$I_D = 6A$
Gate-Drain Charge	Q _{gd}	-	3	-	nC	
Turn-On Delay Time	t _{D(on)}	-	2.5	-	ns	
Turn-On Rise Time	tr	-	6.6	-	ns	$V_{DD} = 15V, V_{GS} = 10V,$
Turn-Off Delay Time	t _{D(off)}	-	19.0	-	ns	$R_{G} = 6\Omega, R_{L} = 1.8\Omega, I_{D} = 6.7A$
Turn-Off Fall Time	t _f	-	6.3	-	ns	

Notes:

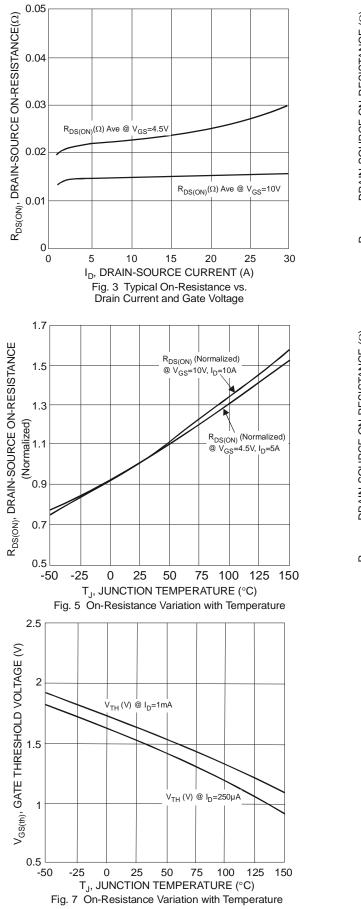
7. Short duration pulse test used to minimize self-heating effect.

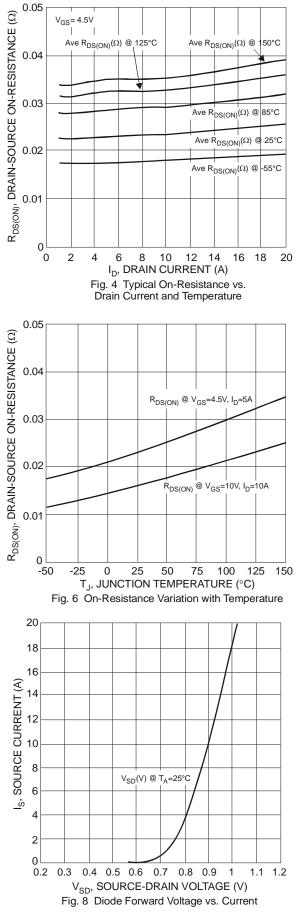
8. Guaranteed by design. Not subject to product testing.





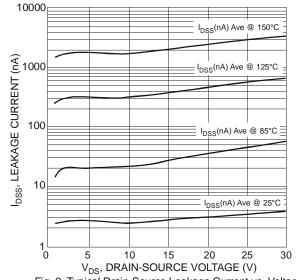




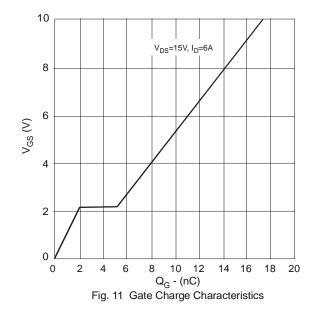


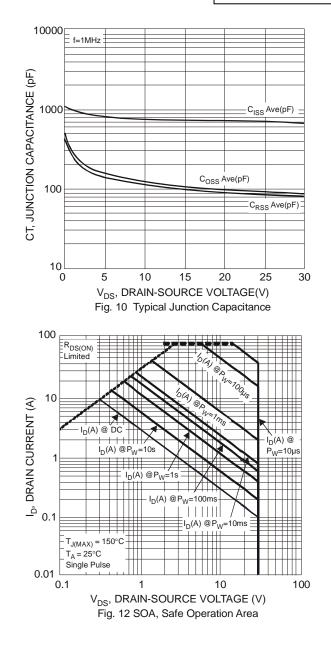
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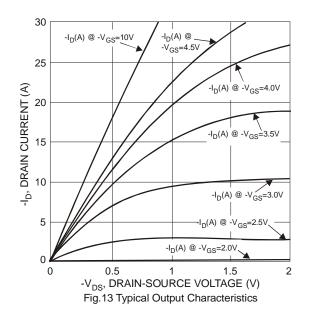


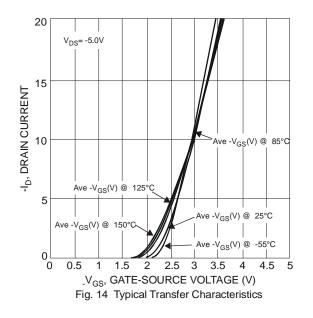


Electrical Characteristics P-CHANNEL – Q2@T_A = 25°C unless otherwise specified

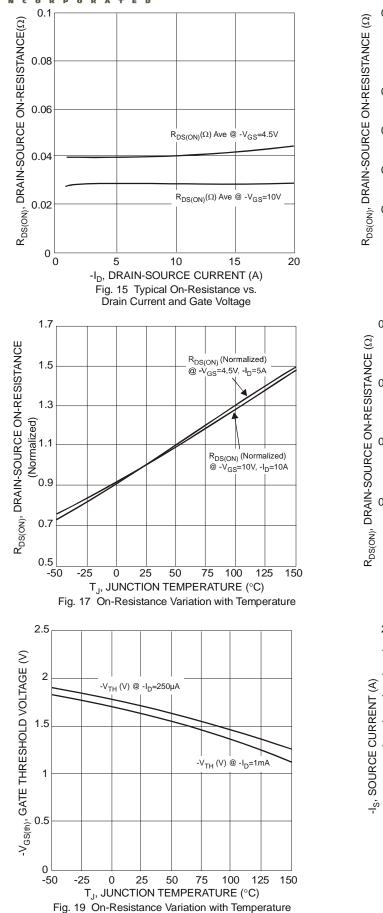
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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)		1	1			
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current @1	Γ _c = 25°C I _{DSS}	-	-	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-1	-1.7	-2.2	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance		-	30	39	Ω	$V_{GS} = -10V, I_D = -4.3A$
	R _{DS (ON)}	-	42	53	2.2	$V_{GS} = -4.5V, I_D = -3.7A$
Forward Transfer Admittance	Y _{fs}	-	10	-	S	$V_{DS} = -5V, I_D = -4.3A$
Diode Forward Voltage (Note 6)	V _{SD}	-	-0.75	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	-	1039	-	pF	
Output Capacitance	C _{oss}	-	144	-	pF	─V _{DS} = -10V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	134	-	pF	
Gate Resistance	Rg	-	13	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (4.5V)	Qg	-	10.1	-	nC	
Total Gate Charge (10V)	Qg	-	21.1	-	nC	V _{GS} = -10V, V _{DS} = -15V,
Gate-Source Charge	Q _{gs}	-	2.8	-	nC	I _D = -6A
Gate-Drain Charge	Q _{gd}	-	3.2	-	nC	
Turn-On Delay Time	t _{D(on)}	-	10.1	-	ns	
Turn-On Rise Time	tr	-	6.5	-	ns	V _{DS} = -15V, V _{GS} = -10V,
Turn-Off Delay Time	t _{D(off)}	-	50.1	-	ns	$R_G = 6\Omega, I_D = -1A$
Turn-Off Fall Time	t _f	-	22.2	-	ns	

 Short duration pulse test used to minimize self-heating effec
Guaranteed by design. Not subject to product testing. Notes:









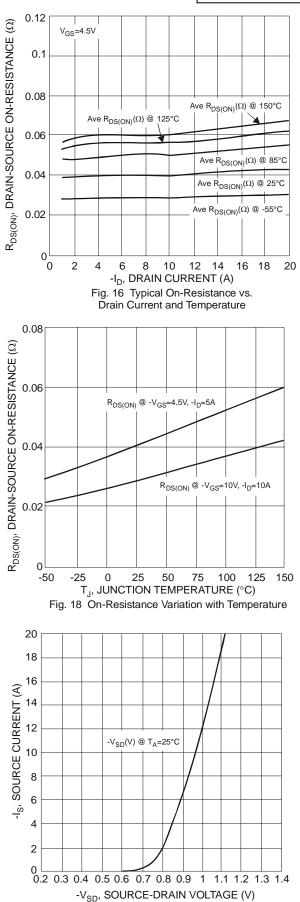
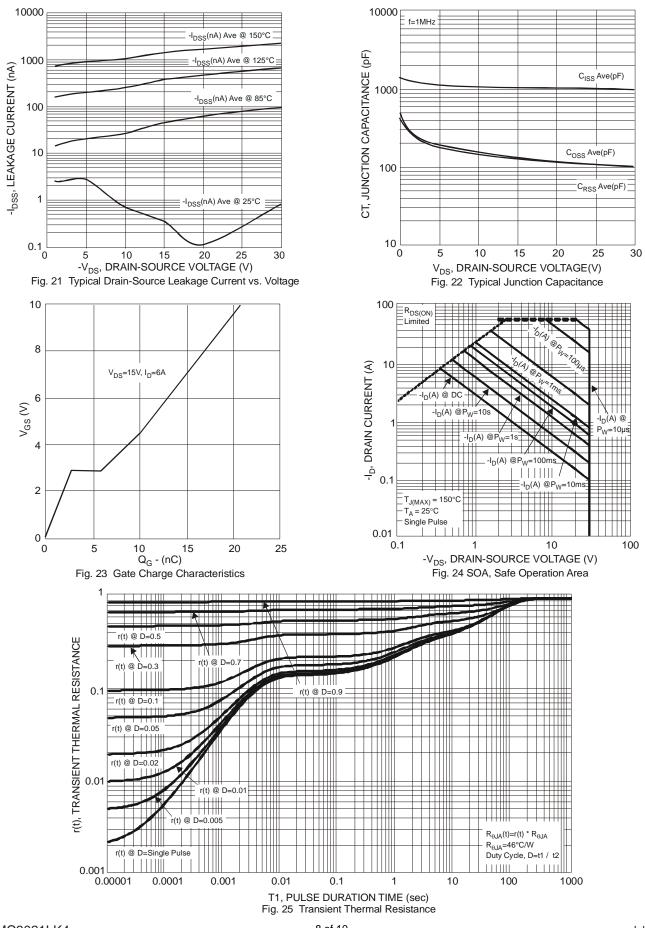


Fig. 20 Diode Forward Voltage vs. Current

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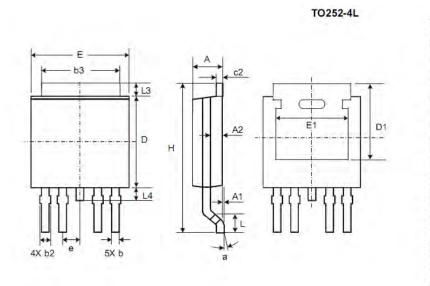




8 of 10 www.diodes.com



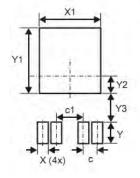
Package Outline Dimensions



	TO2	52-4L	
Dim	Min	Max	Тур
Α	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.51	0.71	0.583
b2	0.61	0.79	0.70
b3	5.21	5.46	5.33
c2	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	1.1401	991
е		F	1.27
Е	6.45	6.70	6.58
E1	4.32	1.4.1	124.7
H	9.40	10.41	9,91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
а	0°	10°	-
AIL	Dimen	sions i	n mm

Suggested Pad Layout

TO252-4L



Dimensions	Value (in mm)
C	1.27
c1	2.54
X	1.00
X1	5.73
Y	2.00
Y1	6.17
Y2	1.64
Y3	2.66

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